## [Define Package Model] Proposed Extension

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# [Define Package Model] POWER & GND Pin Connection Additions

- Allows option for combining POWER or GND pin package models within existing IBIS specification for Power Integrity analysis
  - o E.g., multi-pin GND plane coupled model based on one pin
  - Supports how some existing package models have been developed using [Component]/[Pin Mapping] keyword
  - Pins without model data due to merging are connected with implicit shorts
- Introduces new [Merged Pins] keyword for explicit connections
  - After [Define Package Model]/[Pin Numbers] and before [Model Data]
  - Works with [Component]/[Pin Mapping] keyword



## [Merged Pins] Syntax Example

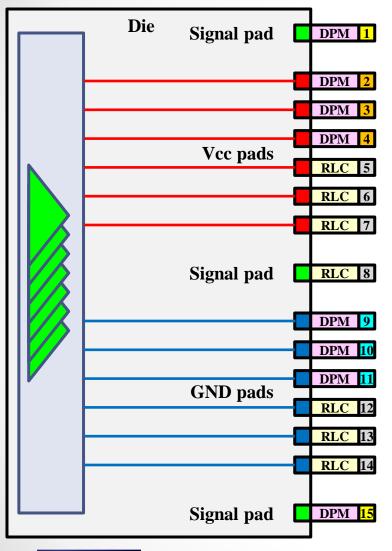
```
[Manufacturer] ACME, Inc.
[OEM] ACME, Inc.
[Description] FBGA Package Model for x4 Data Pins and POWER/GND
[Number of Pins] 13
[Pin Numbers]
A1 IVDD
A2 | VSSQ
A8 | VSSQ
A9 IVSS
B2 | VDDQ
B3 | DQS c
B7 | DQ1
C2 | DQ0
C3 | DQS t
C7 | VDD
D3 | D02
D7 | DO3
D9 IVSSO
[Merged Pins] A1
H1 M1 | Merged VDD
[Merged Pins] C7
F9 J9 N9 | Merged VDD (electrically in parallel with A1, shorted at the die)
[Merged Pins] A9
C8 E9 G1 H9 K1 K9 N1 | Merged VSS
[Merged Pins] A2
D1 | Merged VSSQ (electrically in parallel with A8 and D9, shorted at the die)
[Merged Pins] B2
B8 C1 C9 E2 E8 | Merged VDDQ
```



## Legend for Pending BIRD Cases

- Without [Merged Pins]
  - o Implicit Short: -----
- DPM: [Define Package Model]/[Pin Numbers] coupled [Model Data] used
- RLC: Default [Pin] R\_pin, L\_pin, C\_pin or [Package]
   R\_pkg, L\_pkg, C\_pkg value under [Component]
- Grey Pin: Not listed in [Pin Numbers]





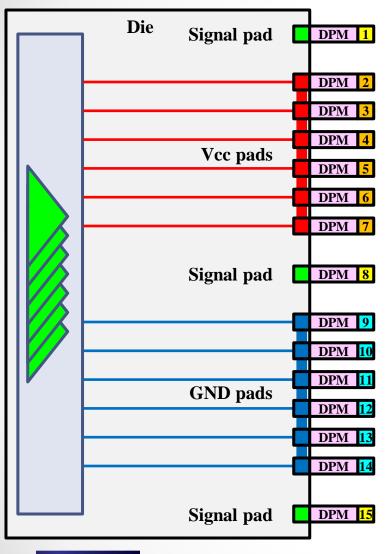
For pins listed under [Pin Numbers] (in color)

 Package model comes from [Define Package Model]

For pins NOT listed under [Pin Numbers] (in gray)

Package RLC comes from [Pin]/[Package]



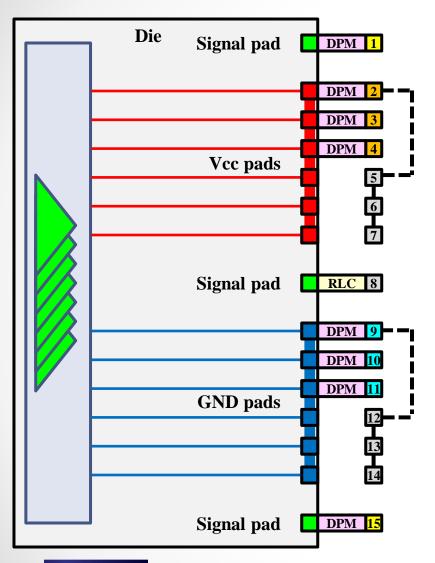


All pins are listed under [Pin Numbers]

Package model comes from [Define Package Model]

Rule applies to both signal and power/ground pins





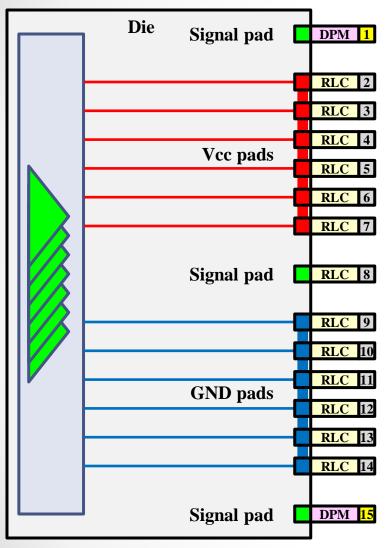
For pins listed under [Pin Numbers] (in color)

Package model comes from [Define Package Model]

For pins NOT listed under [Pin Numbers] (in gray)

- Signal pins: package RLC comes from [Pin]/[Package]
- Power/ground pins: NO package RLC should be used
- Implicit connection to first pin listed in [Pin Numbers]
- EDA tools now expected to support this option
- EDA tools may provide interface to select where unlisted pins are attached to pins listed under [Pin

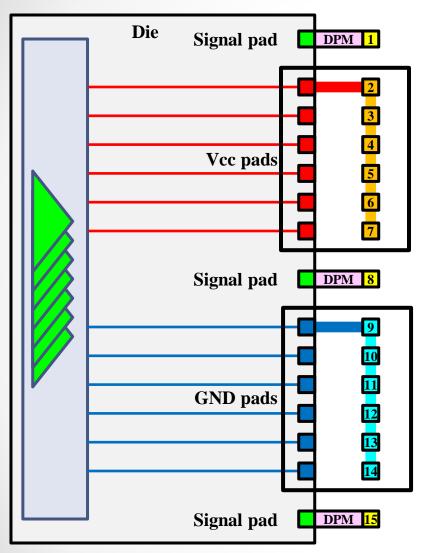




No bussed pins are listed under [Pin Numbers] (in gray)

• Package RLC should be used

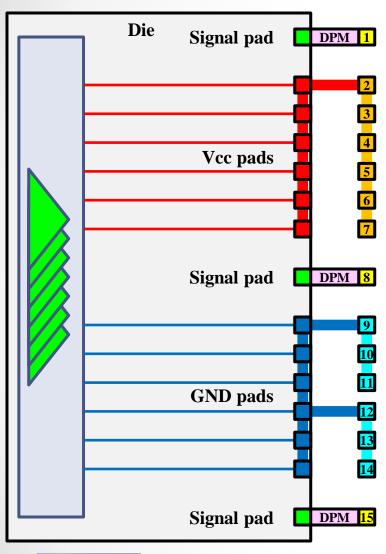




#### **Illegal**

[Pin Mapping] bus is required to align with [Merged Pins] connections

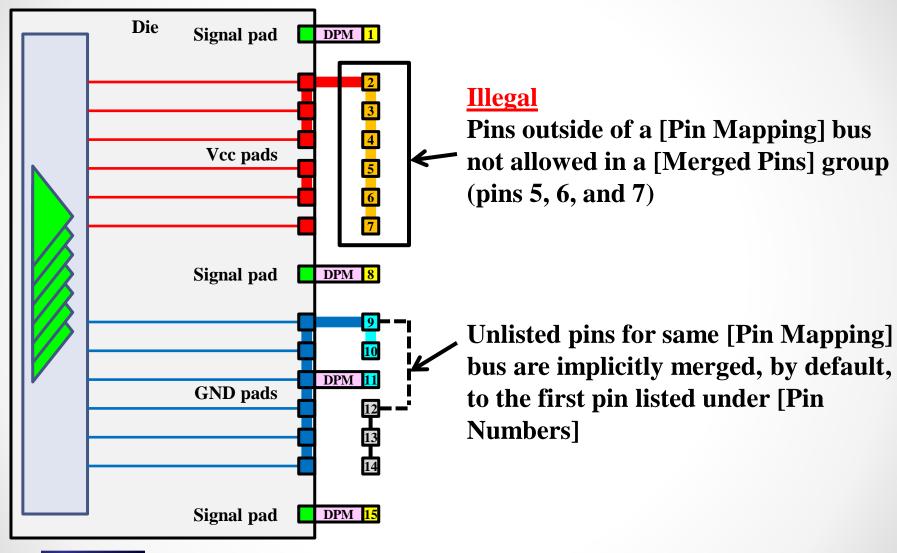




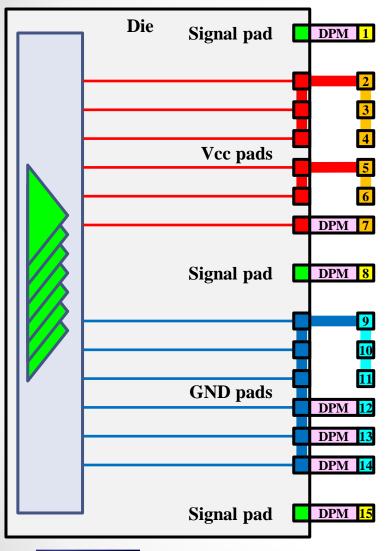
## All pins are listed under [Pin Numbers]

- Package model comes from [Define Package Model]
- [Merged Pins] keyword defines connection to [Pin Numbers] entries
- Pins 3-7, 10-11, and 13-14 are NOT in [Pin Numbers] list, but in [Merged Pins] list
- [Pin Mapping] busses can be associated with several [Merged Pins] groups









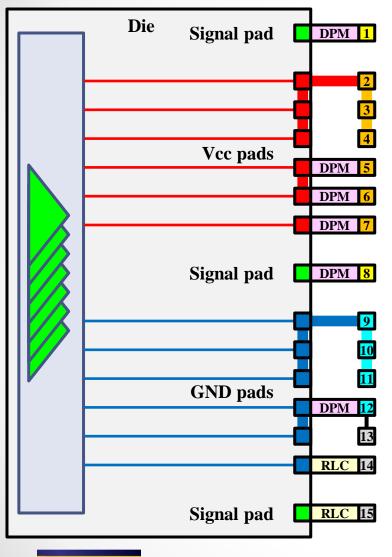
#### **Legal Cases**

[Pin Mapping] busses and [Merged Pins] listings are aligned

Pin 7 is on a separate [Pin Mapping] bus

Pins 12-14 listed under [Pin Numbers] and these pins should use the [Define Package Model] data





#### **Legal Cases**

[Merged Pins] used for pins 3, 4 to 2 and for pins 10, 11 to 9

For pins NOT listed under [Pin Numbers] (in gray)

- Pin 13: NO package RLC should be used
- Pin 13 is on same [Pin Mapping] bus as pin 12 and is implicitly merged to pin 12

Unlisted pin 14 is on separate bus and connected by RLC model (as is the signal pin 15)



### Conclusion

- BIRD176 being prepared for Version 6.1
- POWER/GND connection option available within existing IBIS for unlisted pins in [Pin Numbers]
- New [Merged Pins] keyword gives explicit connections
- Questions, comments?

